

Title (en)

DEVICE FOR THE HEAT TREATMENT OF WORKPIECES

Title (de)

VORRICHTUNG ZUR THERMISCHEN BEHANDLUNG VON WERKSTÜCKEN

Title (fr)

DISPOSITIF DE TRAITEMENT THERMIQUE DE PIÈCES

Publication

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Application

EP 09775874 A 20090518

Priority

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- DE 202008011595 U 20080901

Abstract (en)

[origin: US2011117513A1] The invention relates to a device for the thermal treatment of workpieces, in particular printed circuit boards or the like equipped with electrical and electronic components, said device comprising a process chamber (1) in which there is formed or arranged at least one heating zone or cooling zone which has a heating device or a cooling device and through which the workpieces are transported along a transporting section while being heated or cooled, wherein a pressurized gaseous fluid can be introduced into the heating zone or the cooling zone via inflow openings (18).

IPC 8 full level

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CPC (source: EP US)

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Citation (search report)

See references of WO 2010006568A1

Citation (examination)

- JP 2002016352 A 20020118 - MATSUSHITA ELECTRIC IND CO LTD
- JP 2004235381 A 20040819 - SONY CORP

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Designated extension state (EPC)

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DOCDB simple family (publication)

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EP 09775874 A 20090518; IL 21050711 A 20110106; JP 2011517745 A 20090518; KR 20107028649 A 20090518; MX 2011000253 A 20090518;
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